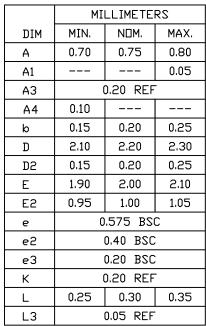
DETAIL

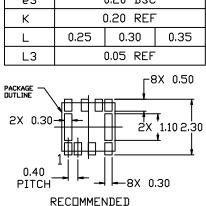
WDFNW8 2.2x2, 0.575P CASE 515AE

DATE 16 AUG 2018

IDTES:

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
- 2. CONTROLLING DIMENSION: MILLIMETERS
- DIMENSION 6 APPLIES TO PLATED TERMINALS AND IS MEASURED BETWEEN 0.15 AND 0.30MM FROM THE TERMINAL TIP.
- COPLANARITY APPLIES TO THE EXPOSED PADS AS WELL AS THE TERMINALS.
- THIS DEVICE CONTAINS WETTABLE FLANK DESIGN FEATURES TO AID IN FILLET FORMATION ON THE LEADS DURING MOUNTING.





MOUNTING FOOTPRINT

2231			ISSUE O	
PIN ONE _ REFERENCE	D A B TOP VIEW	Lr3	ALTERNATE	N□ 1. 2. 3.
DE // 0.10 C 0.08 C NDTE 4	TAIL B C SIDE VIEW	▼ SEATING C PLANE	DETAIL A CONSTRUCTION	, 2.
EZ-	+\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\	L	PLATED SURFACE SECTION C-	-C

0.10 C A B

PLÄTED

SURFACE

GENERIC MARKING DIAGRAM*

BOTTOM VIEW

XX M

XX = Specific Device Code = Date Code

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "■", may or may not be present. Some products may not follow the Generic Marking.

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DESCRIPTION:	WDFNW8 2.2x2, 0.575P		PAGE 1 OF 1	

EXPOSED

COPPER

PLATED

SURFACE

DETAIL B

ALTERNATE CONSTRUCTION

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